







J110, J110A N-Channel JFET

Features

InterFET <u>N0450S Geometry</u>
 Low Noise: 1 nV/VHz Typical

• High Gain: 100mS Typical

RoHS Compliant

• SMT, TH, and Bare Die Package options.

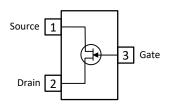
Applications

- Choppers
- Commutators
- Analog Switches

Description

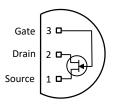
The -25V InterFET J110 and J110A JFET's are targeted for high gain low noise switching, commutator, and chopper applications.

SOT23 Top View





TO-92 Bottom View





Product Summary

Parameters		J110 Min	J110A Min	Unit
BV _{GSS}	Gate to Source Breakdown Voltage	-25	-25	V
I _{DSS}	Drain to Source Saturation Current	10	10	mA
V _{GS(off)}	Gate to Source Cutoff Voltage	-0.5	-0.5	V

Ordering Information Custom Part and Binning Options Available

Part Number	Description	Case	Packaging
J110; J110A	Through-Hole	TO-92	Bulk
SMPJ110; SMPJ110A	Surface Mount	SOT23	Bulk
	7" Tape and Reel: Max 3,000 Pieces		Minimum 1,000 Pieces
SMPJ110TR; SMPJ110ATR	13" Tape and Reel: Max 9,000 Pieces	SOT23	Tape and Reel
J110COT; J110ACOT	Chip Orientated Tray (COT Waffle Pack)	СОТ	400/Waffle Pack
J110CFT; J110ACFT	Chip Face-up Tray (CFT Waffle Pack)	CFT	400/Waffle Pack



Disclaimer: It is the Buyers responsibility for designing, validating and testing the end application under all field use cases and extreme use conditions. Guaranteeing the application meets required standards, regulatory compliance, and all safety and security requirements is the responsibility of the Buyer. These resources are subject to change without notice.









Electrical Characteristics

Maximum Ratings (@ TA = 25°C, Unless otherwise specified)

	Parameters	Value	Unit				
V_{RGS}	Reverse Gate Source and Gate Drain Voltage	-25	V				
I _{FG}	Continuous Forward Gate Current	50	mA				
P _D	Continuous Device Power Dissipation	360	mW				
Р	Power Derating	3.27	mW/°C				
Tı	Operating Junction Temperature	-55 to 125	°C				
T _{STG}	Storage Temperature	-65 to 200	°C				

Static Characteristics (@ TA = 25°C, Unless otherwise specified)

			J110		J110A		
	Parameters	Conditions	Min	Max	Min	Max	Unit
V _{(BR)GSS}	Gate to Source Breakdown Voltage	V _{DS} = 0V, I _G = -1μA	-25		-25		٧
I _{GSS}	Gate to Source Reverse Current	V _{GS} = -15V, V _{DS} = 0V		-3		-3	nA
V _{GS(OFF)}	Gate to Source Cutoff Voltage	$V_{DS} = 5V$, $I_D = 1\mu A$	-0.5	-4	-0.5	-4	V
I _{DSS}	Drain to Source Saturation Current	$V_{GS} = 0V$, $V_{DS} = 15V$ (Pulsed)	10		10		mA
I _D	Drain Cutoff Current	V _{DS} = 5V, V _{GS} = -10V		3		3	nA

Dynamic Characteristics (@ TA = 25°C, Unless otherwise specified)

			J110		J110A		
	Parameters	Conditions	Min	Max	Min	Max	Unit
R _{DS(ON)}	Drain to Source ON Resistance	V _{DS} <= 0.1V, V _{GS} = 0V, f = 1kHz		18		25	Ω
C _{gd}	Drain Gate Capacitance	V _{DS} = 0V, V _{GS} = -10V, f = 1MHz		15		15	pF
Cgs	Input Capacitance	V _{DS} = 0V, V _{GS} = -10V, f = 1MHz		15		15	pF
C _{gd} + C _{gs}	Drain + Source Gate Capacitance	$V_{DS} = V_{GS} = 0V$, $f = 1MHz$		85		85	pF
t _{d(ON)}	Turn ON Delay Time		4 (typ)		4 (t	4 (typ)	
t _r	Rise Time	V_{DD} = 1.5V, $V_{GS(OFF)}$ = -5V, R_L = 150 Ω	1 (typ)		1 (typ)		ns
t _{d(OFF)}	Turn OFF Delay Time		6 (typ)		6 (typ)		ns
tf	Fall Time		30 (typ)		30 (typ)		ns



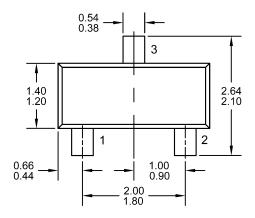


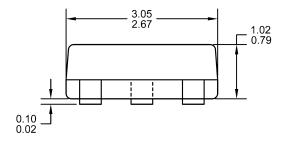


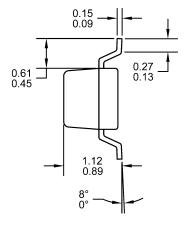


SOT23 (TO-236AB) Mechanical and Layout Data

Package Outline Data

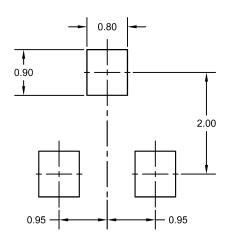






- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.12 grams
- 3. Molded plastic case UL 94V-0 rated
- For Tape and Reel specifications refer to InterFET CTC-021 Tape and Reel Specification, Document number: IF39002
- Bulk product is shipped in standard ESD shipping material
- 6. Refer to JEDEC standards for additional information.

Suggested Pad Layout



- 1. All linear dimensions are in millimeters.
- 2. The suggested land pattern dimensions have been provided for reference only. A more robust pattern may be desired for wave soldering.



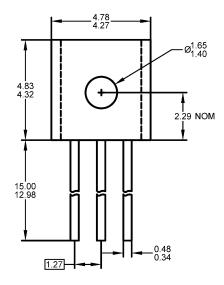


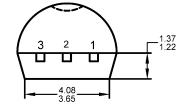


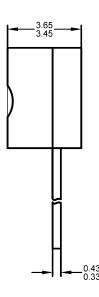


TO-92 Mechanical and Layout Data

Package Outline Data

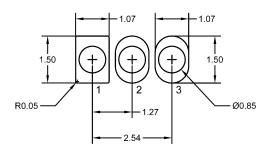






- 1. All linear dimensions are in millimeters.
- 2. Package weight approximately 0.19 grams
- 3. Molded plastic case UL 94V-0 rated
- Bulk product is shipped in standard ESD shipping material
- 5. Refer to JEDEC standards for additional information.

Suggested Through-Hole Layout



- 1. All linear dimensions are in millimeters.
- The suggested land pattern dimensions have been provided as a straight lead reference only. A more robust pattern may be desired for wave soldering and/or bent lead configurations.

Mouser Electronics

Authorized Distributor

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InterFET:

<u>J110</u> <u>SMPJ110</u> <u>SMPJ110A</u> <u>J110A</u>